# 5-1761613-5 - ACTIVE

### STEP-Z

TE Internal #: 5-1761613-5 PCB Mount Receptacle, Vertical, Board-to-Board, 104 Position, 1.3 mm [.051 in] Centerline, Gold, Surface Mount - Solder Ball, Power & Signal, Natural

View on TE.com >

Connectors > PCB Connectors > PCB Headers & Receptacles



PCB Connector Assembly Type: PCB Mount Receptacle

PCB Mount Orientation: Vertical

Connector System: Board-to-Board

Number of Positions: 104

Number of Rows: 2

### Features

### Product Type Features

PCB Connector Assembly Type

Connector System

Sealable

PCB Mount Receptacle

Board-to-Board

No



Printed Circuit Board

### **Configuration Features**

Stackable	Yes		
PCB Mount Orientation	Vertical		
Number of Positions	104		
Number of Rows	2		
Board-to-Board Configuration	Parallel		
Electrical Characteristics			
Dielectric Withstanding Voltage (Max)	500 VAC		
Insulation Resistance	18 MΩ		
Operating Voltage	48 VAC		
Body Features			
Primary Product Color	Natural		
Contact Features			
Contact Layout	Matrix		

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Mating Tab Width	1 mm[.04 in]		
Mating Tab Thickness	.2 mm[.008 in]		
Contact Shape & Form	Dual Beam, Single Beam		
PCB Contact Termination Area Plating Material	Tin-Silver		
Contact Base Material	Copper Alloy		
Contact Mating Area Plating Material	Gold		
Contact Mating Area Plating Material Thickness	.76 μm[29.9212 μin]		
Contact Type	Socket		
Contact Current Rating (Max)	1 A		
Termination Features			
Termination Method to Printed Circuit Board			
	Surface Mount - Solder Ball		
Mechanical Attachment	Surface Mount - Solder Ball		
	Surface Mount - Solder Ball With		
Mechanical Attachment			
Mechanical Attachment Mating Retention	With		
Mating Retention Mating Alignment	With Without		
Mechanical Attachment   Mating Retention   Mating Alignment   PCB Mount Retention	With Without Without		

### Housing Features

Centerline (Pitch)	1.3 mm[.051 in]
Housing Material	Thermoplastic
Dimensions	
Connector Height	10.65 mm[.419 in]
Row-to-Row Spacing	2 mm[.079 in]
Stack Height	15 mm, 17 mm, 18 mm, 20 mm, 25 mm[.984 in]
PCB Thickness (Recommended)	1.57 mm[.8 in]
Usage Conditions	
Operating Temperature Range	0-100 °C[32-212 °F]
Operation/Application	
Assembly Process Feature	None
Circuit Application	Power & Signal
Industry Standards	

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UL Flammability Rating	UL 94V-0
Packaging Features	
Packaging Quantity	30
Packaging Method	Tray
Product Compliance For compliance documentation, visit the product page on TE.com>	
EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JAN 2024 (240) Candidate List Declared Against: JAN 2024 (240) Does not contain REACH SVHC
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free
Solder Process Capability	Reflow solder capable to 260°C

#### Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

# **Compatible Parts**



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# Customers Also Bought

TE			
TE Part #2007637-8 SFP+ assy 2x2 Spring Fingers N	TE Part #5787962-1 .8MM CHAMP STACK RCPT ASSY	TE Part #9-6318491-6 .5FHP08H,220,S,GIG,08/Sn,HT,NSYes, W/C	TE Part #5223008-1 FB-5R,ASY,030,SIG,REC,EN,3.55
	TE TE		
TE Part #1766685-1 CONN,SKT,LONG SLDR,MC-P3S0	TE Part #1888971-4 QSFP TB CAGE ASSY, W/LP, NO HS	TE Part #2377200-1 DMD 149 SOCKET ASSY, S450, REEL	TE Part #6-2170705-2 CAGE ASSY, QSFP28 1X1, SPRING,

CONN,SKT,LONG SLDK,MC-P350	QSFF TB CAGE ASSY, W/LP, NO HS	DIVID 149 SOCKET ASSY, S430, REEL	HS, LP
TE Part #1714836-1 CABLE CMDFRMA PRMA/MDF LINK	TE Part #1714846-1 INTCCPU CABLE		

## Documents

Product Drawings STEP-Z RCPT 05MM 104P LF ST

English

### **CAD** Files

### 3D PDF

3D

Customer View Model

ENG\_CVM\_CVM\_5-1761613-5\_A.2d\_dxf.zip

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English

Customer View Model ENG\_CVM\_CVM\_5-1761613-5\_A.3d\_igs.zip

English

**Customer View Model** 

ENG\_CVM\_CVM\_5-1761613-5\_A.3d\_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Datasheets & Catalog Pages STEP-Z Interconnection System

English

Product Specifications Application Specification

English